

Simulations of Turbulent Diffusion in Wire-Wrapped Sodium Fast Reactor Fuel Assemblies

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Overview

- Background and Motivation
- Multi-scale approach to design and safety analysis
- Review of initial results
- Recent Results
- Full-size assembly simulation benchmarking
- Conclusions and Future Work



Path Forward to Future Commercial ABR's

- Path Forward
 - Design simplifications (reduce mass of steel)
 - Compact reactor vessel
 - Compact intermediate components
 - Advanced compact fuel handling systems
 - New technologies that allow for reduced structural materials inventory and compact piping systems
 - Improved management of design and safety margins



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Role of Advanced Simulations

- Need to develop multi-resolution modeling approach capable of quantifying the complex interactions from fuel centerline to the ultimate heat sink.
 - This presents a challenge because of the large domains in time (10⁻⁷ seconds to years) and space (10⁻⁶ meters to 10s of meters).
 - In the absence of experiments, higher-fidelity models need to provide accurate, geometry-dependent parameters to lower-fidelity models that can capture much larger domains in both space and time.

T/H Modeling Domains





Thermofluid Code Development



Sub-channel and lumped parameter methods provide low resolution temperature fields for full plant

> LES simulations provide higher resolution 3-D turbulence fields for smaller components → Improved turbulence models for RANS simulation



RANS simulations provide high resolution 3-D temperature fields for large components → Improved models for lower fidelity simulations

DNS simulations provide first principles turbulence fields for small characteristic geometries → Improved sub-grid models for LES simulations



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Key Findings 06-08: Direct Numerical Simulation of TurbulencePlane Channel + Wire in Cross FlowR. Ranjan & C. Pantano, UIUC

- Single wire in a channel with cross flow simulated at Re_b=6000 using a spectral code: gold standard turbulence benchmark
- 3 million node hours through INCITE award.



Ranjan, Pantano, & Fischer, DNS of swept flow over a wire in a channel, J. Fluid Mech., 2009 (in review).

Key Findings 06-08: LES of SFR Subassemblies

7 pin wire-wrapped assemblies

P. Fischer, A. Obabko and J. Lottes, Argonne

- Transition to turbulence with inflow/outflow boundary conditions occurs at $z\sim30 D_h$
 - Verified in: single-pin x periodic array and 7-pin x 3H subassembly
 - Therefore: axial periodicity is warranted \rightarrow significant savings (10 x)



Transition in a 7-pin subassembly with laminar inflow conditions

- LES and RANS simulations give comparable results for cross-flow distributions in 7-pin case:
 - We have a mechanism for validating RANS, which gives considerable savings.
 - Data provides direct input to core-scale simulations



Key Findings 06-08: RANS Simulations of SFR Assemblies

7-37pin wire-wrapped assemblies

- Demonstrated evolution of flow field from 7 to 217 pin assemblies
 - Reduced importance of bulk swirling and increased complexity of flow field with increasing pin count
 - Fundamental change in flow behavior between 19- and 37-pin assemblies
 - Consistent with evidence in pressure drop data sets

D. Pointer, Argonne and J. Smith, Uldaho



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Power Distribution Difference in predicted temperature



Predicted Dimensionless Pressure Loss Coefficient from RANS Simulations vs. Correlations

- The dimensionless pressure loss coefficient is the pressure drop normalized by the dynamic head, so that Cp=f (L/D).
- The Cheng & Todreas correlation assumes that there are three fundamental subchannel types: interior, edge, and corner. Each of the three types of sub-channel frictional losses is calculated separately. The bundle friction factor is then averaged.
- The Rehme correlation is a simpler single equation formulation based on representative geometric parameters.

Number of Pins	Cheng & Todreas Correlation	Rehme Correlation	RANS Simulation Prediction
7*	$1.116 \pm 14\%$	$1.179 \pm 5\%$	2.282
19	1.088± 14%	$1.041 \pm 5\%$	1.199
37	$1.075 \pm 14\%$	0.943 ± 5%	1.059

* Small 7-pin assemblies are not within the range of applicability of the correlations



LES Simulations of 217 pin assemblies

- Using spectral element code Nek5000
 - Single wire pitch H with periodicity in the axial direction
 - Reynolds number reduced to Re_D=15000 to reduce computational burden
 - Based on prior experience with smaller assemblies
 - Confirm scaling with RANS simulations
 - 2.95 million spectral elements of order N=7 (n=1.01 billion)
 - Have also run N=9 (n=2.1 billion)
 - Under-resolved particularly axially
 - 4x larger than any previous Nek5000 run





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RANS Simulations of 217 pin assemblies

- Using commercial code STAR-CCM+
 - 5 wire pitches, 5H, with inflow/outflow boundary conditions
 - Reynolds number reduced to Re_D=15000 to match LES conditions
 - 22 milion cells
 - Have also run n=44million
 - Under-resolved particularly axially







Benchmarking of LES vs RANS

- Extract field data along selected planes.
- Calculate velocity component normal to plane
- Average data across plane to collapsed data to an axial profile of average normal velocity







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RANS Simulations Re_h=15000 vs Re_h=108,000





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Conclusions

- A series of LES and RANS based CFD simulations of a 217-pin wire-wrapped sodium-cooled fast reactor fuel assembly have been completed
 - initial benchmark of RANS models against high fidelity LES simulations in large wire wrapped pin bundles.
- Initial comparisons show that RANS and LES predict similar transverse flow fields within the assembly – a well mixed flow through the central channels and a swirling flow through the edge channels along the assembly boundary.
 - Much different than the flow field in 7- and 19-pin assemblies where swirling flow dominates
- Comparisons of RANS to 1-D subchannel simulations reveal bias in temperature distribution as a consequence of azimuthal starting position of the wire relative to can wall.
- Comparisons of detailed inter-channel exchange velocity profiles show that the two methods generally agree.
 - RANS simulations tend to predict more inter-channel mixing
 - Less turbulence generation on the windward side of the wire wrap spacer



Current Efforts: Turblent Diffusion

- Benchmarking of turbulent diffusion based on legacy experiments
- Water experiments using conduction probes to track plume diffusion
 - Use single injection port in variety of sub-channel locations
- For the interior channels, one observes that fluid is swept into the channel from which the wire is exiting.
- Discharge into the other subchannels is not evenly split between the neighboring subchannels – there is a significant bias for the flow to follow the wire
- By z=H, the peak concentration has typically moved two or three channels.







Current Efforts: Design Studies

- Alternative edge channel geometries
- Wire wrap vs. Spacer Grid



Questions?

